January 2004

## FDS6694

FAIRCHILD SEMICONDUCTOR

### 30V N-Channel Fast Switching PowerTrench<sup>0</sup> MOSFET

#### **General Description**

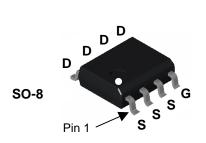
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $R_{DS(ON)}$  and fast switching speed.

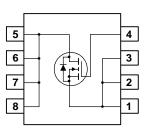
#### Applications

- DC/DC converter
- Power management
- Load switch

#### Features

- 12 A, 30 V.  $R_{DS(ON)} = 11 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$  $R_{DS(ON)} = 13.5 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$
- Low gate charge (13 nC typical)
- High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$
- High power and current handling capability.





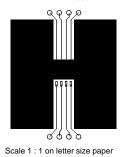
#### Absolute Maximum Ratings T<sub>A=25°C</sub> unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		30	V
V <sub>GSS</sub>	Gate-Source Voltage		±20	V
I <sub>D</sub>	Drain Current – Continuous	(Note 1a)	12	А
	– Pulsed		50	
P <sub>D</sub>	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.4	
		(Note 1c)	1.2	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperate	ure Range	-55 to +175	°C
Therma	I Characteristics			
R <sub>0JA</sub>	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient	(Note 1c)	125	°C/W
R <sub>0JC</sub>	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

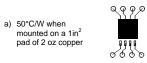
Device Marking	Device	Reel Size	Tape width	Quantity	
FDS6694	FDS6694	13"	12mm	2500 units	

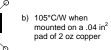
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics		1	I	L	L
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = 250 \mu A$	30			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		22		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 24 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			10	μA
I <sub>GSS</sub>	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V},  V_{DS} = 0 \text{ V}$			±100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1	2	3	V
$\Delta V_{GS(th)}$ $\Delta T_J$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		-5		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance			9.1 11.1 12.2	11 13.5 15	mΩ
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = 10 \text{ V}, \qquad V_{DS} = 5 \text{ V}$	50			Α
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 V$ , $I_{D} = 12 A$		50		S
Dvnamio	c Characteristics					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 15 V$ , $V_{GS} = 0 V$ ,		1293		pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz		342		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			136		pF
R <sub>G</sub>	Gate Resistance			0.84		Ω
Switchir	ng Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = 15 V$ , $I_D = -1 A$ ,		9	18	ns
tr	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		6	12	ns
t <sub>d(off)</sub>	Turn–Off Delay Time			28	45	ns
t <sub>f</sub>	Turn–Off Fall Time			10	20	ns
Qg	Total Gate Charge	$V_{DS} = 15 \text{ V}, \qquad I_D = 12 \text{ A},$		13	19	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = 5 V$		4		nC
Q <sub>gd</sub>	Gate–Drain Charge			4.7		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain-Source				2.1	Α
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$ , $I_S = 2.1 A$ (Note 2)		0.74	1.2	V
t <sub>rr</sub>	Diode Reverse Recovery Time	$I_F = 12 \text{ A},  d_{iF}/d_t = 100 \text{ A}/\mu \text{s}$		29		nS
Q <sub>rr</sub>	Diode Reverse Recovery Charge			30		nC



2. Pulse Test: Pulse Width < 300 $\mu$ s, Duty Cycle < 2.0%

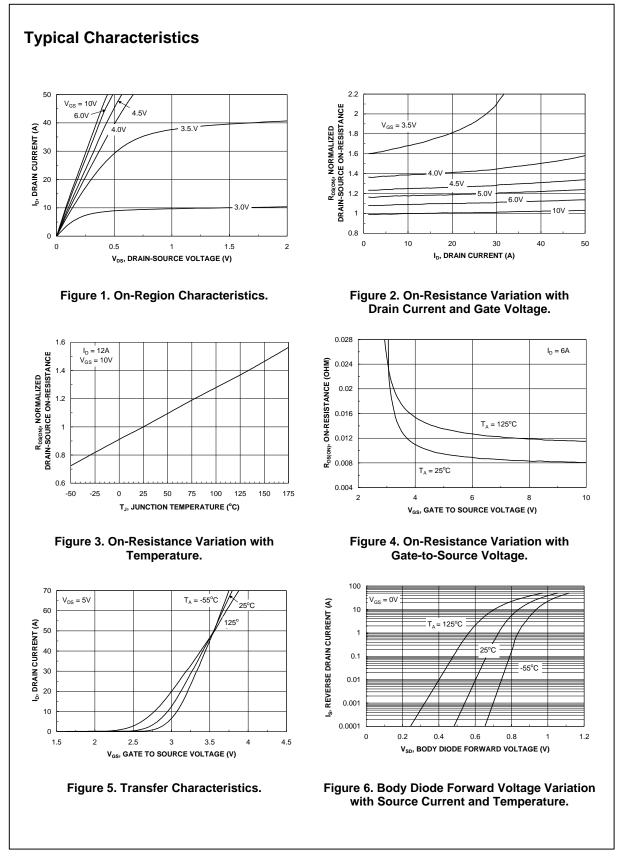




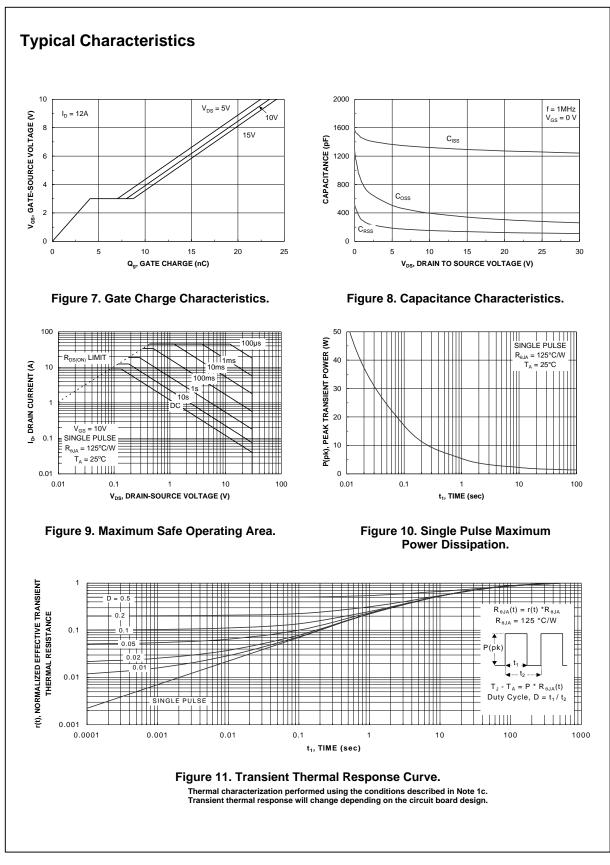
c) 125°C/W when mounted on a minimum pad.

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FDS6694 Rev.E(W)



# FDS6694



FDS6694

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#### **PRODUCT STATUS DEFINITIONS**

**Definition of Terms** 

Product Status	Definition
Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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#### FDS6694

30V N-Channel Fast Switching PowerTrench MOSFET

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#### General description

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Product status/pricing/packaging



Product	Product status	Pb-free Status	Package type	Leads	Packing method	Package Marking Convention**
FDS6694	Not recommended for new designs	۲	<u>SO-8</u>	8	TAPE REEL	Line 1: <b>\$Y</b> (Fairchild logo) & <b>Z</b> (Asm. Plant Code) & <b>2</b> (2-Digit Date Code) & <b>T</b> (Die Trace Code) Line 2: FDS Line 3: 6694
FDS6694_NF073	Not recommended for new designs	۲	<u>SO-8</u>	8	TAPE REEL	Line 1: <b>\$Y</b> (Fairchild logo) & <b>Z</b> (Asm. Plant Code) & <b>2</b> (2-Digit Date Code) & <b>T</b> (Die Trace Code) Line 2: FDS Line 3: 6694

Indicates product with Pb-free second-level interconnect. For more information click here.

Package marking information for product FDS6694 is available. Click here for more information .

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#### Models

Package & leads	Condition	Temperature range	Derature range Software version Revision date		
PSPICE					
SO-8-8         Electrical         25°C to 125°C         Orcad 9.1         Jul 8, 2003		Jul 8, 2003			

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#### **Qualification Support**

Click on a product for detailed qualification data

Product			
FDS6694			
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